Texas Instruments

Bill of Materials

TI DESIGNS TIPD188: AC Bridge Excitation Technique for Bridge Stabilization

Quantity	Value	Designator	Description	Manufacturer	PartNumber	Supplier 1	Supplier Part Number 1
10		+5V, BR_O+, BR_O-, BR_R+, BR_R-, EXC_GPIO_N, EXC_GPIO_P, GND1, GND2, GND3	TEST POINT, MINIATURE, SMT	Keystone Electronics	5015	Digi-Key	5015KCT-ND
1	4700pF	C1	CAP, CERM, 4700 pF, 50V, +/-10%, X7R, 0603	MuRata	GRM188R71H472KA01D	Digi-Key	490-1506-1-ND
6	1µF	C2, C5, C7, C8, C9, C10	CAP, CERM, 1uF, 16V, +/-10%, X5R, 0603	MuRata	GRM185R61C105KE44D	Digi-Key	490-3894-1-ND
2	0.1µF	C3, C6	CAP, CERM, 0.1uF, 16V, +/-10%, X7R, 0603	MuRata	GRM188R71C104KA01D	Digi-Key	490-1532-1-ND
2	100n	C4, C11	CAP, CERM X2Y, 100 nF, 25V, X7R, +/-20%, 0805	Johanson Dielectrics Inc	250X15W104MV4E	Digi-Key	709-1330-1-ND
1	10µF	C12	CAP, CERM, 10 uF, 16V, X7R +/-20%, 1206	TDK	C3216X7R1C106M160AC	Digi-Key	445-1601-1-ND
1	0.01uF	C13	CAP, CERM, 0.01uF, 25V, +/-10%, X7R, 0603	MuRata	GRM188R71E103KA01D	Digi-Key	490-1520-1-ND
1	10uF	C14	CAP, CERM, 10 uF, 16V, X7R +/-20%, 1206	ТДК	C3216X7R1C106M	Digi-Key	445-1601-1-ND
1	6.2V	D1	DIODE, ZENER, 6.2V, 500mW, SOD-123	Diodes Inc	DDZ6V2B-7	Digi-Key	DDZ6V2BDICT-ND
2		J1, J2	Connector, Receptacle, 100mil, 10x2, Gold plated, SMD	Samtec	SSW-110-22-F-D-VS-K	Digi-Key	SSW-110-22-F-D-VS-K-ND
5	100k	R1, R2, R26, R27, R28	RES, 100k Ohm, 5%, 1/10W, 0603	Panasonic	ERJ-3GEYJ104V	Digi-Key	P100KGCT-ND
4	350	R4, R5, R14, R15	RES, 350 Ohm, 0.25%, 0.3W, 1206	Vishay	804-1206	Digi-Key	804-1206-ND
2	87.325k	R6, R13	RES, 87.325k Ohm, 0.01%, 0.75W, 2512	Vishay	804-2512	Digi-Key	804-2512-ND
2	47	R8, R10	RES, 47 Ohm, 1%, 1/10W, 0603	Panasonic	ERJ-3EKF47R0V	Digi-Key	P47.0HCT-ND
6	47	R9, R12, R16, R18, R19, R20	RES, 47 Ohm, 1%, 1/10W, 0603	Panasonic	ERJ-3EKF47R0V	Digi-Key	P47.0HCT-ND
4	0	R21, R22, R25, R24	RES, 0 Ohm, 5%, 0.1W, 0603	Rohm	MCR03EZPJ000	Digi-Key	RHM0.0GCT-ND
2		S1, S4	Switch, Toggle, SPST, 1Pos, TH	E-Switch	200USP9T1A1M2RE	Digi-Key	EG4914-ND
1		U1	IC, 32-bit, 38kSPS ADC	Texas Instruments	ADS1263IPW	Texas Instruments	ADS1263IPW
2		U2, U3	IC, Single-Channel 10 Ohms SPDT Analog Switch	Texas Instruments	TS5A21366RSER	Texas Instruments	TS5A21366RSER

IMPORTANT NOTICE FOR TI REFERENCE DESIGNS

Texas Instruments Incorporated ("TI") reference designs are solely intended to assist designers ("Buyers") who are developing systems that incorporate TI semiconductor products (also referred to herein as "components"). Buyer understands and agrees that Buyer remains responsible for using its independent analysis, evaluation and judgment in designing Buyer's systems and products.

TI reference designs have been created using standard laboratory conditions and engineering practices. **TI has not conducted any testing other than that specifically described in the published documentation for a particular reference design.** TI may make corrections, enhancements, improvements and other changes to its reference designs.

Buyers are authorized to use TI reference designs with the TI component(s) identified in each particular reference design and to modify the reference design in the development of their end products. HOWEVER, NO OTHER LICENSE, EXPRESS OR IMPLIED, BY ESTOPPEL OR OTHERWISE TO ANY OTHER TI INTELLECTUAL PROPERTY RIGHT, AND NO LICENSE TO ANY THIRD PARTY TECHNOLOGY OR INTELLECTUAL PROPERTY RIGHT, IS GRANTED HEREIN, including but not limited to any patent right, copyright, mask work right, or other intellectual property right relating to any combination, machine, or process in which TI components or services are used. Information published by TI regarding third-party products or services does not constitute a license to use such products or services, or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of TI.

TI REFERENCE DESIGNS ARE PROVIDED "AS IS". TI MAKES NO WARRANTIES OR REPRESENTATIONS WITH REGARD TO THE REFERENCE DESIGNS OR USE OF THE REFERENCE DESIGNS, EXPRESS, IMPLIED OR STATUTORY, INCLUDING ACCURACY OR COMPLETENESS. TI DISCLAIMS ANY WARRANTY OF TITLE AND ANY IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE, QUIET ENJOYMENT, QUIET POSSESSION, AND NON-INFRINGEMENT OF ANY THIRD PARTY INTELLECTUAL PROPERTY RIGHTS WITH REGARD TO TI REFERENCE DESIGNS OR USE THEREOF. TI SHALL NOT BE LIABLE FOR AND SHALL NOT DEFEND OR INDEMNIFY BUYERS AGAINST ANY THIRD PARTY INFRINGEMENT CLAIM THAT RELATES TO OR IS BASED ON A COMBINATION OF COMPONENTS PROVIDED IN A TI REFERENCE DESIGN. IN NO EVENT SHALL TI BE LIABLE FOR ANY ACTUAL, SPECIAL, INCIDENTAL, CONSEQUENTIAL OR INDIRECT DAMAGES, HOWEVER CAUSED, ON ANY THEORY OF LIABILITY AND WHETHER OR NOT TI HAS BEEN ADVISED OF THE POSSIBILITY OF SUCH DAMAGES, ARISING IN ANY WAY OUT OF TI REFERENCE DESIGNS OR BUYER'S USE OF TI REFERENCE DESIGNS.

TI reserves the right to make corrections, enhancements, improvements and other changes to its semiconductor products and services per JESD46, latest issue, and to discontinue any product or service per JESD48, latest issue. Buyers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All semiconductor products are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its components to the specifications applicable at the time of sale, in accordance with the warranty in TI's terms and conditions of sale of semiconductor products. Testing and other quality control techniques for TI components are used to the extent TI deems necessary to support this warranty. Except where mandated by applicable law, testing of all parameters of each component is not necessarily performed.

TI assumes no liability for applications assistance or the design of Buyers' products. Buyers are responsible for their products and applications using TI components. To minimize the risks associated with Buyers' products and applications, Buyers should provide adequate design and operating safeguards.

Reproduction of significant portions of TI information in TI data books, data sheets or reference designs is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. TI is not responsible or liable for such altered documentation. Information of third parties may be subject to additional restrictions.

Buyer acknowledges and agrees that it is solely responsible for compliance with all legal, regulatory and safety-related requirements concerning its products, and any use of TI components in its applications, notwithstanding any applications-related information or support that may be provided by TI. Buyer represents and agrees that it has all the necessary expertise to create and implement safeguards that anticipate dangerous failures, monitor failures and their consequences, lessen the likelihood of dangerous failures and take appropriate remedial actions. Buyer will fully indemnify TI and its representatives against any damages arising out of the use of any TI components in Buyer's safety-critical applications.

In some cases, TI components may be promoted specifically to facilitate safety-related applications. With such components, TI's goal is to help enable customers to design and create their own end-product solutions that meet applicable functional safety standards and requirements. Nonetheless, such components are subject to these terms.

No TI components are authorized for use in FDA Class III (or similar life-critical medical equipment) unless authorized officers of the parties have executed an agreement specifically governing such use.

Only those TI components that TI has specifically designated as military grade or "enhanced plastic" are designed and intended for use in military/aerospace applications or environments. Buyer acknowledges and agrees that any military or aerospace use of TI components that have **not** been so designated is solely at Buyer's risk, and Buyer is solely responsible for compliance with all legal and regulatory requirements in connection with such use.

TI has specifically designated certain components as meeting ISO/TS16949 requirements, mainly for automotive use. In any case of use of non-designated products, TI will not be responsible for any failure to meet ISO/TS16949.

Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265 Copyright © 2015, Texas Instruments Incorporated